

# ESDBL6V8P

## SILICON EPITAXIAL PLANAR DIODE

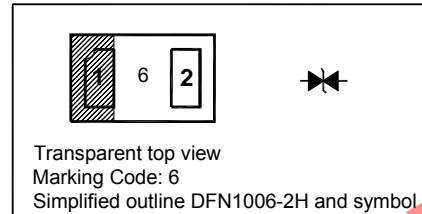
ESD protection diode

### Features

- Ultra small mold type
- Bi-direction high reliability

### PINNING

PIN	DESCRIPTION
1	Anode
2	Anode

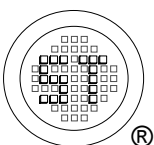
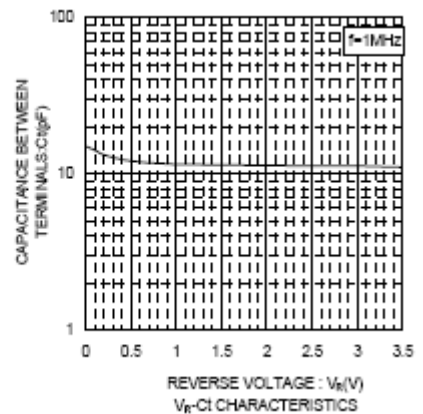
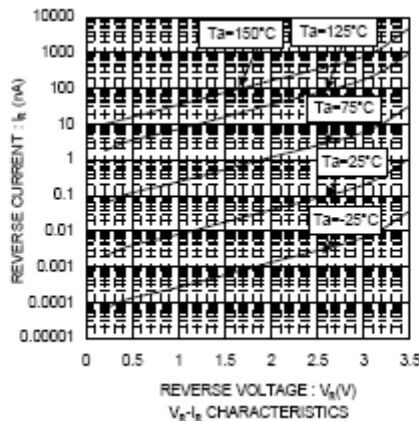
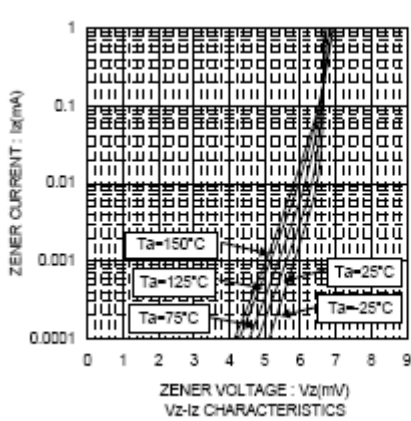


### Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp = 10 X 1000 μs)	P <sub>PK</sub>	10	W
Power Dissipation	P <sub>D</sub>	100	mW
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>stg</sub>	- 55 to + 150	°C
Operation Temperature Range	T <sub>opr</sub>	- 55 to + 150	°C

### Characteristics at T<sub>a</sub> = 25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit
Zener Voltage at I <sub>Z</sub> = 1 mA	V <sub>Z</sub>	5.78	-	7.82	V
Reverse Current at V <sub>R</sub> = 3.5 V	I <sub>R</sub>	-	-	0.5	μA
Capacitance between Terminals at V <sub>R</sub> = 0 V, f = 1 MHz	C <sub>T</sub>	-	15	-	pF



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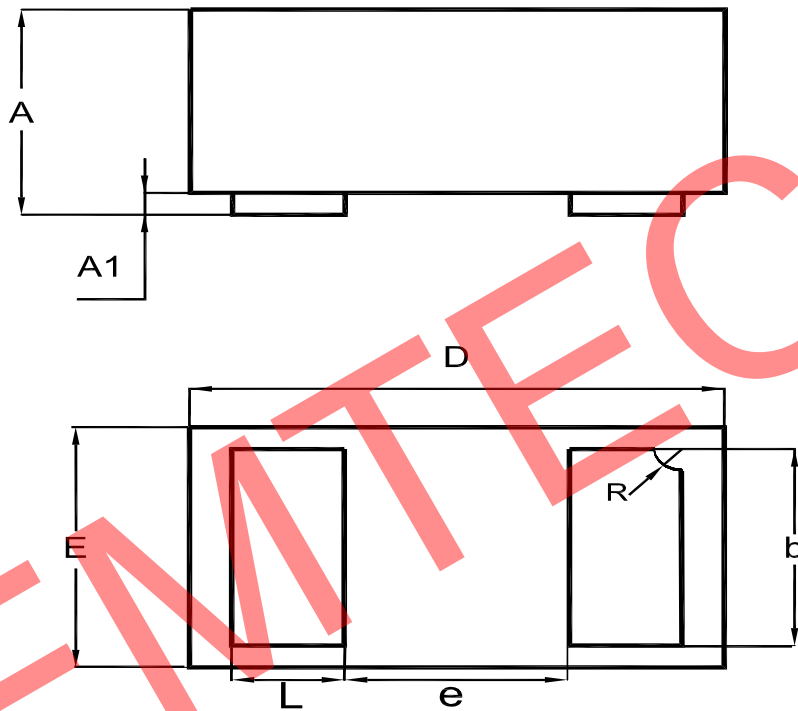


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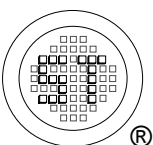
## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

DFN1006-2H



UNIT	A	A1	b	D	E	e	L	R
mm	0.51	0.05	0.55	1.075	0.675	0.4	0.3	0.15
	0.46	0	0.45	0.95	0.55		0.2	0.05



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Dated: 16/07/2013 Rev: 01